G3VM-21LR1

MOS FET Relays

World's Smallest* SSOP Package MOS FET Relays with Low Output Capacitance and ON Resistance (C \times R = 5 pF • Ω) in a 20-V Load Voltage Model.

ullet ON resistance of 1 Ω (typical) suppresses output signal attenuation.

* As of August 2014 Survey by OMRON

RoHS compliant



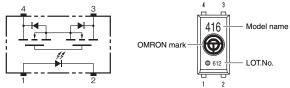
AI

Note: The actual product is marked differently from the image shown here.

■ Application Examples

- Semiconductor test equipment
- Test & Measurement equipment
- Communication equipment
- Data loggers

■ Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

■ List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity Number per tape and reel
SSOP4	1a (SPST-NO)	Surface-mounting Terminals	20 V	G3VM-21LR1	-
				G3VM-21LR1 (TR05)	500

Note: Ask your OMRON representative for orders under 500 pcs. We can supply products with the tape already cut.

Tape-cut SSOPs are packaged without humidity resistance. Use manual soldering to mount them.

Refer to common precautions.

* The AC peak and DC value are given for the load voltage.

■ Absolute Maximum Ratings (Ta = 25 °C)

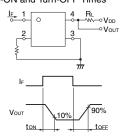
Item		Symbol	Rating	Unit	Measurement conditions
	LED forward current	lF	50	mA	
Ħ	LED forward current reduction rate	∆lf/°C	-0.5	mA/°C	Ta ≥ 25 °C
<u>d</u>	LED reverse voltage	VR	5	٧	
	Connection temperature	TJ	125	°C	
	Load voltage (AC peak/DC)	Voff	20	V	
Output	Continuous load current (AC peak/DC)	lo	450	mA	
	ON current reduction rate	∆lo/°C	-4.5	mA/°C	Ta ≥ 25 °C
	Pulse ON current	Гор	1.35	Α	t = 100 ms, Duty = 1/10
	Connection temperature	TJ	125	°C	
	electric strength between (See note 1.)	VI-O	1500	Vrms	AC for 1 min
Ambient operating temperature		Ta	–20 to +85	°C	With no icing or condensation
Am	bient storage temperature	Tstg	-40 to +125	°C	With no icing or condensation
Soldering temperature		-	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

■ Electrical Characteristics (Ta = 25 °C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
	LED forward voltage	VF	1.0	1.15	1.3	V	IF = 10 mA
=	Reverse current	lr	-	-	10	μΑ	VR = 5 V
Input	Capacity between terminals	Ст	-	15	-	рF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	-	-	4	mΑ	Io = 100 mA
	Turn-OFF LED forward current	IFC	0.2	-	-	mΑ	Ioff = 10 μA
Output	Maximum resistance with output ON	Ron	-	0.8	1.2	Ω	IF = 5 mA, Io = 450 mA, t = 10 ms
	Current leakage when the relay is open	ILEAK	-	-	1.0	nA	Voff = 20 V, Ta = 50 °C
	Capacity between terminals	Coff	-	5	12	рF	V = 0, f = 100 MHz, t < 1 s
Capacity between I/O terminals		Cı-o	-	0.8	-	pF	f = 1 MHz, Vs = 0 V
Insulation resistance between I/O terminals		Rı-o	1000	108	-	$M\Omega$	V _I -o = 500 VDC, RoH ≤ 60 %
Turn-ON time		ton	-	0.2	0.5	ms	IF = 5 mA, RL = 200 Ω ,
Turn-OFF time		toff	-	0.2	0.5	ms	V _{DD} = 10 V (See note 2.)

Note: 2. Turn-ON and Turn-OFF Times



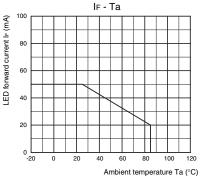
■ Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

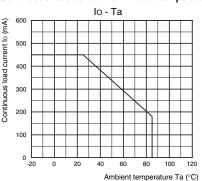
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V _{DD}	-	-	20	V
Operating LED forward current	lF	10	-	30	mA
Continuous load current (AC peak/DC)	lo	-	-	450	mA
Ambient operating temperature	Та	-20	-	60	°C

■ Engineering Data

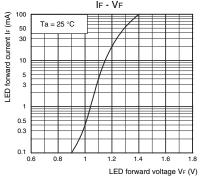
LED forward current vs. Ambient temperature



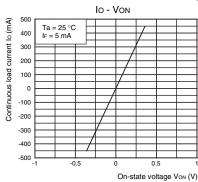
Continuous load current vs. Ambient temperature



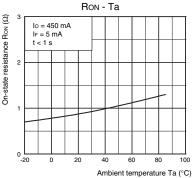
LED forward current vs. LED forward voltage



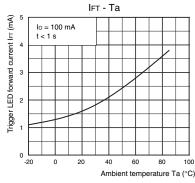
Continuous load current vs. On-state voltage



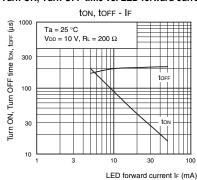
On-state resistance vs. Ambient temperature



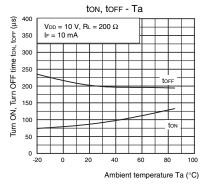
Trigger LED forward current vs. Ambient temperature



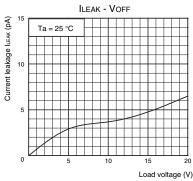
Turn ON, Turn OFF time vs. LED forward current



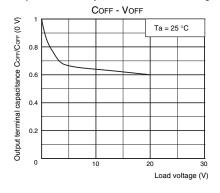
Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Load voltage



Output terminal capacitance vs. Load voltage



■ Safety Precautions

• Refer to "Common Precautions" for all G3VM models.

■ Appearance

SSOP (Shrink Small Outline Package)

SSOP4



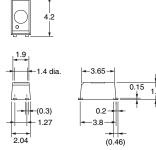
Note: The actual product is marked differently from the image shown here.

■ Dimensions (Unit: mm)



Surface-mounting Terminals

Weight: 0.03 g



Unless otherwise specified, the dimensional tolerance is ± 0.1 mm.

Note: The actual product is marked differently from the image shown here.

Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



Contact: www.omron.com/ecb

Note: Do not use this document to operate the Unit.

Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
 Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad

Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad
systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious
influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or
equipment, and be sure to provide the system or equipment with double safety mechanisms.